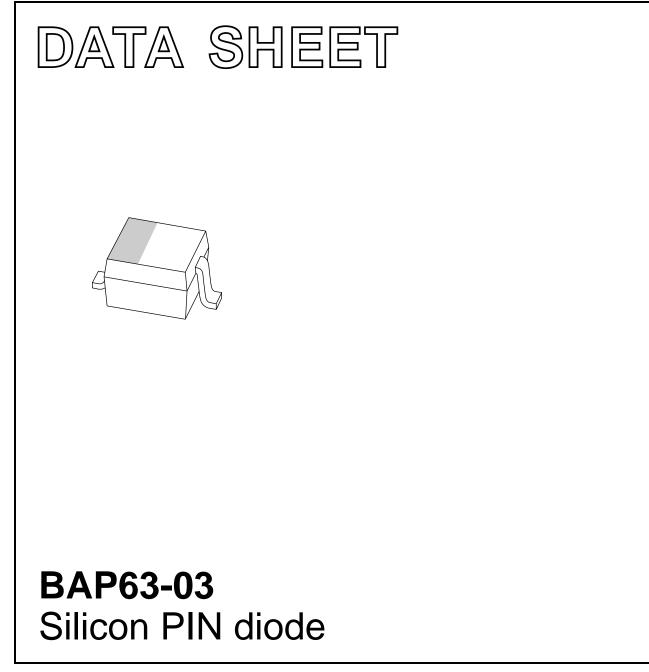
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 May 18 2004 Feb 11



Product specification

BAP63-03

FEATURES

- High speed switching for RF signals
- Low diode capacitance
- Low diode forward resistance
- Very low series inductance
- For applications up to 3 GHz.

APPLICATIONS

• RF attenuators and switches.

DESCRIPTION

Planar PIN diode in a SOD323 small SMD plastic package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	

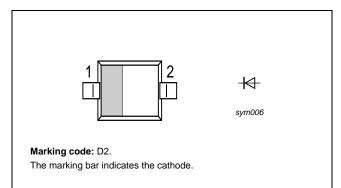


Fig.1 Simplified outline (SOD323) and symbol.

ORDERING INFORMATION

TYPE		PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION	
BAP63-03	_	plastic surface mounted package; 2 leads	SOD323	

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		-	50	V
I _F	continuous forward current		-	100	mA
P _{tot}	total power dissipation	$T_s \le 90 \ ^{\circ}C$	-	500	mW
T _{stg}	storage temperature		-65	+150	°C
Т _ј	junction temperature		-65	+150	°C

BAP63-03

ELECTRICAL CHARACTERISTICS

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 50 mA	0.95	1.1	V
I _R	reverse leakage current	V _R = 35 V	-	10	nA
C _d	diode capacitance	V _R = 0; f = 1 MHz	0.4	_	pF
		V _R = 1 V; f = 1 MHz	0.35	_	pF
		V _R = 20 V; f = 1 MHz	0.27	0.32	pF
r _D	diode forward resistance	I _F = 0.5 mA; f = 100 MHz; note 1	2.5	3.5	Ω
		I _F = 1 mA; f = 100 MHz; note 1	1.95	3	Ω
		I _F = 10 mA; f = 100 MHz; note 1	1.17	1.8	Ω
		I _F = 100 mA; f = 100 MHz; note 1	0.9	1.5	Ω
s ₂₁ ²	isolation	V _R = 0; f = 900 MHz	15.4	_	dB
		V _R = 0; f = 1800 MHz	10.1	_	dB
		V _R = 0; f = 2450 MHz	7.8	_	dB
s ₂₁ ²	insertion loss	I _F = 0.5 mA; f = 900 MHz	0.21	-	dB
		I _F = 0.5 mA; f = 1800 MHz	0.28	-	dB
		I _F = 0.5 mA; f = 2450 MHz	0.38	-	dB
s ₂₁ ²	insertion loss	I _F = 1 mA; f = 900 MHz	0.18	-	dB
		I _F = 1 mA; f = 1800 MHz	0.26	-	dB
		I _F = 1 mA; f = 2450 MHz	0.35	-	dB
s ₂₁ ²	insertion loss	I _F = 10 mA; f = 900 MHz	0.13	-	dB
		I _F = 10 mA; f = 1800 MHz	0.20	-	dB
		I _F = 10 mA; f = 2450 MHz	0.30	-	dB
S ₂₁ ²	insertion loss	I _F = 100 mA; f = 900 MHz	0.10	_	dB
		I _F = 100 mA; f = 1800 MHz	0.18	-	dB
		I _F = 100 mA; f = 2450 MHz	0.28	-	dB
τ∟	charge carrier life time	when switched from $I_F = 10$ mA to $I_R = 6$ mA; $R_L = 100 \Omega$; measured at $I_R = 3$ mA	310	-	ns
L _S	series inductance		1.5	-	nH

Note

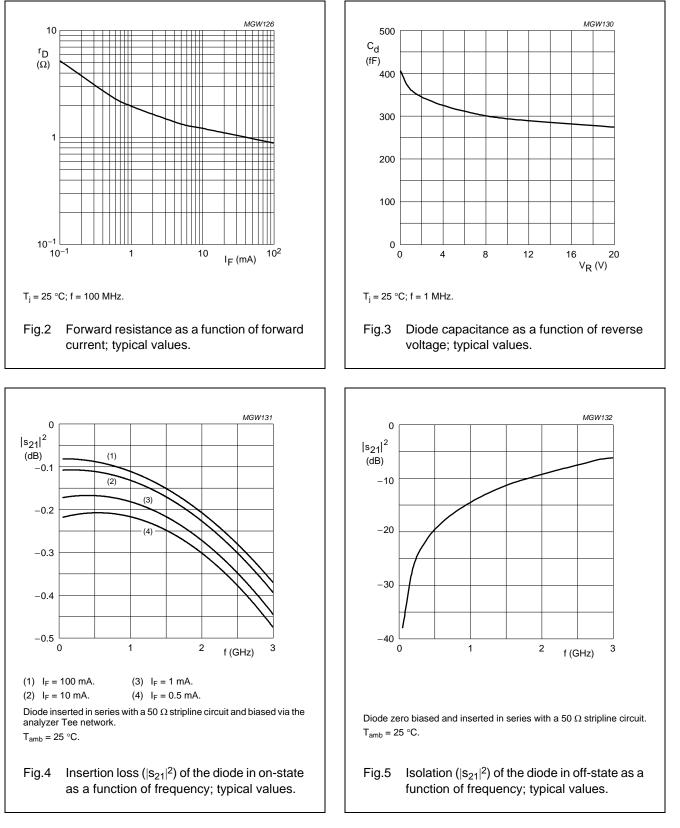
1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

THERMAL CHARACTERISTICS

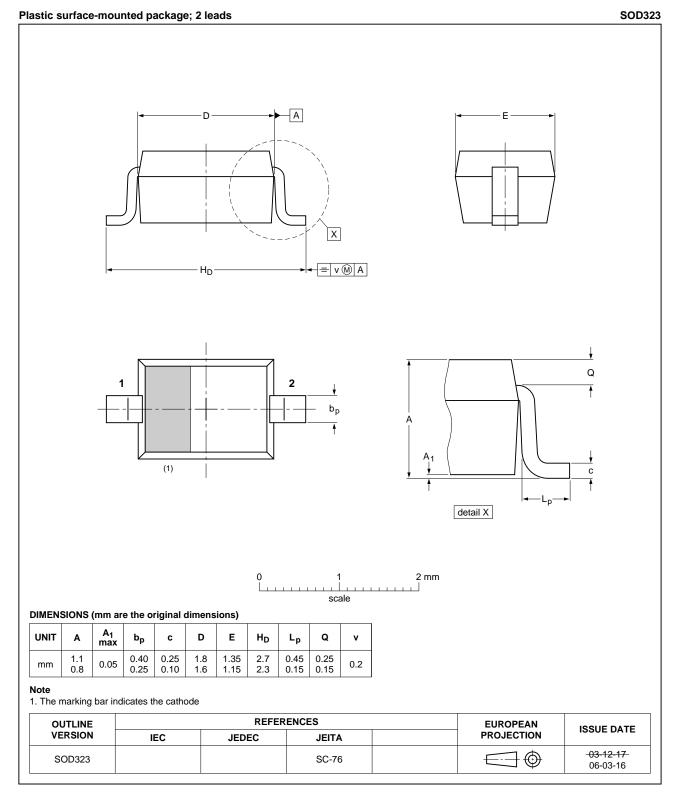
SYMBOL	PARAMETER	VALUE	UNIT
R _{th(j-s)}	thermal resistance from junction to soldering point	120	K/W

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PACKAGE OUTLINE



BAP63-03

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Silicon PIN diode

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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